imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



Data Sheet

FEATURES

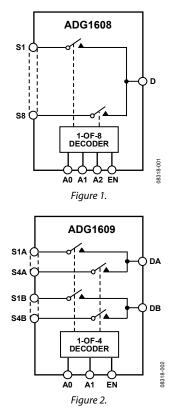
4.5 Ω typical on resistance 1 Ω on-resistance flatness Up to 470 mA continuous current ±3.3 V to ±8 V dual-supply operation 3.3 V to 16 V single-supply operation No V_L supply required 3 V logic-compatible inputs Rail-to-rail operation 16-lead TSSOP and 16-lead, 3 mm × 3 mm LFCSP

APPLICATIONS

Communication systems Medical systems Audio signal routing Video signal routing Automatic test equipment Data acquisition systems Battery-powered systems Sample-and-hold systems Relay replacements

ADG1608/ADG1609

FUNCTIONAL BLOCK DIAGRAMS



GENERAL DESCRIPTION

The ADG1608/ADG1609 are monolithic CMOS analog multiplexers comprising eight single channels and four differential channels, respectively. The ADG1608 switches one of eight inputs to a common output, as determined by the 3-bit binary address lines, A0, A1, and A2. The ADG1609 switches one of four differential inputs to a common differential output, as determined by the 2-bit binary address lines, A0 and A1. An EN input on both devices is used to enable or disable the device. When disabled, all channels are switched off.

Each switch conducts equally well in both directions when on and has an input signal range that extends to the supplies. In the off condition, signal levels up to the supplies are blocked. All switches exhibit break-before-make switching action. Inherent in the design is low charge injection for minimum transients when switching the digital inputs. The low on resistance of these switches make them ideal solutions for data acquisition and gain switching applications where low on resistance and distortion is critical. The on-resistance profile is very flat over the full analog input range, ensuring excellent linearity and low distortion when switching audio signals.

CMOS construction ensures ultralow power dissipation, making the parts ideally suited for portable and battery-powered instruments.

PRODUCT HIGHLIGHTS

- 1. 8 Ω maximum on resistance over temperature.
- 2. Minimum distortion: THD + N = 0.04%
- 3. 3 V logic-compatible digital inputs: $V_{INH} = 2.0$ V, $V_{INL} = 0.8$ V.
- 4. No V_L logic power supply required.
- 5. Ultralow power dissipation: <8 nW.
- 6. 16-lead TSSOP and 16-lead, $3 \text{ mm} \times 3 \text{ mm}$ LFCSP.

Rev. A

Document Feedback

Information furnished by Analog Devices is believed to be accurate and reliable. However, no responsibility is assumed by Analog Devices for its use, nor for any infringements of patents or other rights of third parties that may result from its use. Specifications subject to change without notice. No license is granted by implication or otherwise under any patent or patent rights of Analog Devices. Trademarks and registered trademarks are the property of their respective owners.

One Technology Way, P.O. Box 9106, Norwood, MA 02062-9106, U.S.A. Tel: 781.329.4700 ©2009–2015 Analog Devices, Inc. All rights reserved. Technical Support www.analog.com

TABLE OF CONTENTS

Features	1
Applications	1
Functional Block Diagrams	1
General Description	1
Product Highlights	1
Revision History	2
Specifications	3
±5 V Dual Supply	3
12 V Single Supply	4
5 V Single Supply	5
3.3 V Single Supply	6

Continuous Current per Channel, S or D	7
Absolute Maximum Ratings	8
ESD Caution	8
Pin Configurations and Function Descriptions	9
Typical Performance Characteristics	11
Test Circuits	14
Terminology	17
Outline Dimensions	
Ordering Guide	

REVISION HISTORY

9/15—Rev. 0 to Rev. A	
Change to Table 7	8
Updated Outline Dimensions	18

7/09—Revision 0: Initial Version

SPECIFICATIONS

±5 V DUAL SUPPLY

 V_{DD} = +5 V \pm 10%, V_{SS} = -5 V \pm 10%, GND = 0 V, unless otherwise noted.

Table 1.

Parameter	25°C	–40°C to +85°C	–40°C to +125°C	Unit	Test Conditions/Comments
ANALOG SWITCH					
Analog Signal Range			V_{DD} to V_{SS}	V	
On Resistance (R _{ON})	4.5			Ωtyp	$V_{s} = \pm 4.5 \text{ V}, I_{s} = -10 \text{ mA}; \text{ see Figure 25}$
	5	7	8	Ωmax	$V_{DD} = \pm 4.5 \text{ V}, \text{ V}_{SS} = \pm 4.5 \text{ V}$
On-Resistance Match Between Channels (ΔR_{ON})	0.12			Ωtyp	$V_{s} = \pm 4.5 \text{ V}, I_{s} = -10 \text{ mA}$
	0.25	0.3	0.35	Ωmax	
On-Resistance Flatness (R _{FLAT(ON)})	1			Ωtyp	$V_{s} = \pm 4.5 V$, $I_{s} = -10 mA$
	1.3	1.7	2	Ωmax	
LEAKAGE CURRENTS					$V_{DD} = +5.5 \text{ V}, \text{ V}_{SS} = -5.5 \text{ V}$
Source Off Leakage, Is (Off)	±0.02			nA typ	$V_s = \pm 4.5 V$, $V_D = \mp 4.5 V$; see Figure 26
	±0.1	±0.5	±3	nA max	$v_3 = \pm 1.5 v_7 v_0 = 14.5 v_7 see Figure 20$
Drain Off Leakage, I₀ (Off)	±0.1 ±0.03	±0.5	<u>-</u> 5	nA typ	
Drain On Leakage, ib (On)	±0.03			пд тур	$V_{S} = \pm 4.5 \text{ V}, V_{D} = \mp 4.5 \text{ V}; \text{ see Figure 26}$
ADG1608	±0.15	±2	±14	nA max	
ADG1609	±0.15	±1	±7	nA max	
Channel On Leakage, I _D , I _S (On)	±0.03			nA typ	$V_S = V_D = \pm 4.5 V$; see Figure 27
	±0.15	±2	±14	nA max	
DIGITAL INPUTS					
Input High Voltage, VINH			2.0	V min	
Input Low Voltage, VINL			0.8	V max	
Input Current, I _{INL} or I _{INH}	±1			nA typ	$V_{IN} = V_{GND} \text{ or } V_{DD}$
			±0.1	μA max	
Digital Input Capacitance, C _{IN}	4			pF typ	
DYNAMIC CHARACTERISTICS ¹					
Transition Time, t _{TRANSITION}	150			ns typ	$R_L = 300 \Omega$, $C_L = 35 pF$
	182	230	258	ns max	$V_s = 2.5 V$; see Figure 28
t _{on} (EN)	106			ns typ	$R_L = 300 \Omega, C_L = 35 pF$
	132	150	160	ns max	$V_s = 2.5 V$; see Figure 30
toff (EN)	113			ns typ	$R_L = 300 \Omega, C_L = 35 pF$
	144	178	202	ns max	$V_s = 2.5 V$; see Figure 30
Break-Before-Make Time Delay, t _D	47			ns typ	$R_L = 300 \Omega, C_L = 35 pF$
, <u>, , , , , , , , , , , , , , , , , , </u>			30	ns min	$V_{s1} = V_{s2} = 2.5 V$; see Figure 29
Charge Injection	24			pC typ	$V_s = 0 V, R_s = 0 \Omega, C_L = 1 nF$; see Figure 31
Off Isolation	-64			dB typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; see Figure 32
Channel-to-Channel Crosstalk	-64			dB typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; see Figure 34
Total Harmonic Distortion + Noise (THD + N)	0.04			% typ	$R_L = 110 \Omega$, $V_S = 5 V p$ -p, $f = 20$ Hz to 20 kHz; see Figure 35
-3 dB Bandwidth	0.01			70 CJ P	$R_L = 50 \Omega$, $C_L = 5 pF$; see Figure 33
ADG1608	40			MHz typ	$m_{\rm E} = 30.22, c_{\rm E} = 3.01, 3cc + 190 c - 35$
ADG1609	71			MHz typ	
Cs (Off)	20			pF typ	$V_s = 0 V, f = 1 MHz$
C_{D} (Off)	20			prtyp	VS = 0 V, I = 1 WI12
ADG1608	120			pF typ	$V_{s} = 0 V, f = 1 MHz$
ADG1609	61			pF typ	$V_s = 0 V, f = 1 MHz$
C_D, C_S (On)	150			n E ta un	V = 0V f = 1 MHz
ADG1608	153			pF typ	$V_s = 0 V, f = 1 MHz$
ADG1609	85			pF typ	$V_s = 0 V, f = 1 MHz$
POWER REQUIREMENTS	0.001				$V_{DD} = +5.5 \text{ V}, \text{ V}_{SS} = -5.5 \text{ V}$
I _{DD}	0.001			μA typ	Digital inputs = 0 V or V _{DD}
			1.0	μA max	
V _{DD} /V _{SS}			±3.3/±8	V min/max	

12 V SINGLE SUPPLY

 V_{DD} = 12 V \pm 10%, V_{SS} = 0 V, GND = 0 V, unless otherwise noted.

Table 2.

Parameter	25°C	–40°C to +85°C	–40°C to +125°C	Unit	Test Conditions/Comments
ANALOG SWITCH	1				
Analog Signal Range			0 V to V _{DD}	v	
On Resistance (R _{ON})	4			Ωtyp	$V_s = 0 V$ to 10 V, $I_s = -10 mA$; see Figure 25
	4.5	6.5	7.5	Ωmax	$V_{DD} = 10.8 V, V_{SS} = 0 V$
On-Resistance Match Between Channels (ΔR_{ON})	0.12			Ωtyp	$V_{\rm S} = 10 \text{ V}, \text{ I}_{\rm S} = -10 \text{ mA}$
	0.25	0.3	0.35	Ωmax	
On-Resistance Flatness (R _{FLAT(ON)})	0.9			Ωtyp	$V_s = 0 V$ to 10 V, $I_s = -10 mA$
	1.2	1.6	1.9	Ωmax	
LEAKAGE CURRENTS					V _{DD} = 13.2 V, V _{SS} = 0 V
Source Off Leakage, I _s (Off)	±0.02			nA typ	$V_{s} = 1 V/10 V$, $V_{D} = 10 V/1 V$; see Figure 26
	±0.1	±0.5	±3	nA max	, , , , , , , , , , , , , , , , , , ,
Drain Off Leakage, I _D (Off)	±0.03			nA typ	$V_s = 1 \text{ V}/10 \text{ V}, V_D = 10 \text{ V}/1 \text{ V};$ see Figure 26
ADG1608	±0.15	±2	±14	nA max	······································
ADG1609	±0.15	 ±1	±7	nA max	
Channel On Leakage, I _D , I _s (On)	±0.03			nA typ	$V_s = V_D = 1 V \text{ or } 10 V$; see Figure 27
	±0.15	±2	±14	nA max	
DIGITAL INPUTS	20.15	<u> </u>		in that	
Input High Voltage, V _{INH}			2.0	V min	
			0.8	V max	
Input Current, Inc or Inn	±1		0.0	nA typ	$V_{IN} = V_{GND} \text{ or } V_{DD}$
	± 1		±0.1	µA max	
Digital Input Capacitance, C _{IN}	4		10.1	pF typ	
	4			prtyp	
Transition Time, t _{TRANSITION}	113			nc turn	$R_L = 300 \Omega, C_L = 35 pF$
Transition Time, transition	141	170	106	ns typ	
+ (EN)	80	172	196	ns max	$V_s = 8 V$; see Figure 28 R _L = 300 Ω , C _L = 35 pF
t _{on} (EN)	80 94	101	110	ns typ	$V_{s} = 8 V_{s}$ see Figure 30
+ (ENI)	94 77	101	110	ns max	$R_L = 300 \Omega$, $C_L = 35 pF$
t _{off} (EN)	93	117	140	ns typ	$V_s = 8 V_s$ see Figure 30
Proak Refere Make Time Delay +	93 47	117	140	ns max	
Break-Before-Make Time Delay, t_{D}	47		20	ns typ	$R_{L} = 300 \Omega, C_{L} = 35 \text{ pF}$
Chause Inication	20		30	ns min	$V_{51} = V_{52} = 8 V$; see Figure 29
Charge Injection	29			pC typ	$V_s = 6 V, R_s = 0 \Omega, C_L = 1 nF$; see Figure 31
Off Isolation	-64			dB typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; see Figure 32
Channel-to-Channel Crosstalk	-64			dB typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; see Figure 34
Total Harmonic Distortion + Noise (THD + N)	0.04			% typ	$R_L = 110 \Omega$, Vs = 5 V p-p, f = 20 Hz to 20 kHz; see Figure 35
-3 dB Bandwidth	10				$R_L = 50 \Omega$, $C_L = 5 pF$; see Figure 33
ADG1608	40			MHz typ	
ADG1609	78			MHz typ	
C _s (Off)	19			pF typ	$V_s = 6 V, f = 1 MHz$
C _D (Off)				-	
ADG1608	117			pF typ	$V_s = 6 V, f = 1 MHz$
ADG1609	59			pF typ	$V_{s} = 6 V, f = 1 MHz$
C _D , C _s (On)					
ADG1608	149			pF typ	$V_s = 6 V, f = 1 MHz$
ADG1609	84			pF typ	$V_{S} = 6 V, f = 1 MHz$
POWER REQUIREMENTS				.	V _{DD} = 12 V
I _{DD}	0.001			μA typ	Digital inputs = 0 V or V_{DD}
			1.0	µA max	
ADG1608	300			μA typ	Digital inputs = 5 V
			480	µA max	
ADG1609	225			μA typ	Digital inputs = 5 V
			360	µA max	
V _{DD}			3.3/16	V min/max	

5 V SINGLE SUPPLY

 V_{DD} = 5 V \pm 10%, V_{SS} = 0 V, GND = 0 V, unless otherwise noted.

Table 3.

Parameter	25°C	–40°Cto +85°C	–40°C to +125°C	Unit	Test Conditions/Comments
ANALOG SWITCH					
Analog Signal Range			$0VtoV_{\text{DD}}$	V	
On Resistance (R _{ON})	8.5			Ωtyp	$V_s = 0$ V to 4.5 V, $I_s = -10$ mA; see Figure 25
	10	12.5	14	Ωmax	$V_{DD} = 4.5 \text{ V}, \text{ V}_{SS} = 0 \text{ V}$
On-Resistance Match Between Channels (ΔR_{ON})	0.15			Ωtyp	$V_{s} = 0 V$ to 4.5 V, $I_{s} = -10 \text{ mA}$
	0.3	0.35	0.4	Ωmax	
On-Resistance Flatness (R _{FLAT(ON)})	1.7			Ωtyp	$V_{s} = 0 V$ to 4.5 V, $I_{s} = -10 \text{ mA}$
	2.3	2.7	3	Ωmax	
LEAKAGE CURRENTS					$V_{DD} = 5.5 \text{ V}, V_{SS} = 0 \text{ V}$
Source Off Leakage, Is (Off)	±0.01			nA typ	$V_{s} = 1 \text{ V}/4.5 \text{ V}, V_{D} = 4.5 \text{ V}/1 \text{ V}$; see Figure 26
	±0.1	±0.5	±3	nA max	
Drain Off Leakage, I _D (Off)	±0.01			nA typ	$V_{\rm S} = 1 \text{ V}/4.5 \text{ V}, V_{\rm D} = 4.5 \text{ V}/1 \text{ V}$; see Figure 26
ADG1608	±0.15	±2	±14	nA max	
ADG1609	±0.15	±1	±7	nA max	
Channel On Leakage, I _D , I _S (On)	±0.01			nA typ	$V_S = V_D = 1 V \text{ or } 4.5 V$; see Figure 27
	±0.15	±2	±14	nA max	
DIGITAL INPUTS					
Input High Voltage, VINH			2.0	V min	
Input Low Voltage, V _{INL}			0.8	V max	
Input Current, I _{INL} or I _{INH}	±1			nA typ	$V_{IN} = V_{GND} \text{ or } V_{DD}$
			±0.1	μA max	
Digital Input Capacitance, C _{IN}	4			pF typ	
DYNAMIC CHARACTERISTICS ¹					
Transition Time, transition	193			ns typ	$R_L = 300 \Omega$, $C_L = 35 pF$
	251	301	339	ns max	$V_s = 2.5 V$; see Figure 28
ton (EN)	115			ns typ	$R_L = 300 \Omega$, $C_L = 35 pF$
	152	171	184	ns max	$V_s = 2.5 V$; see Figure 30
t _{off} (EN)	140			ns typ	$R_L = 300 \Omega$, $C_L = 35 pF$
	184	225	259	ns max	$V_s = 2.5 V$; see Figure 30
Break-Before-Make Time Delay, t _D	66			ns typ	$R_L = 300 \Omega$, $C_L = 35 pF$
			37	ns min	$V_{S1} = V_{S2} = 2.5 V$; see Figure 29
Charge Injection	11			pC typ	$V_{s} = 2.5 V$, $R_{s} = 0 \Omega$, $C_{L} = 1 nF$; see Figure 31
Off Isolation	-64			dB typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 100 kHz$; see Figure 32
Channel-to-Channel Crosstalk	-64			dB typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 100 kHz$; see Figure 34
Total Harmonic Distortion + Noise (THD + N)	0.3			% typ	$R_L = 110 \Omega$, f = 20 Hz to 20 kHz, Vs = 3.5 V p-p; see Figure 35
–3 dB Bandwidth					$R_L = 50 \Omega$, $C_L = 5 pF$; see Figure 33
ADG1608	37			MHz typ	
ADG1609	72			MHz typ	
Cs (Off)	22			pF typ	$V_{s} = 2.5 V, f = 1 MHz$
C _D (Off)					$V_{s} = 2.5 V, f = 1 MHz$
ADG1608	136			pF typ	
ADG1609	68			pF typ	
C _D , C _s (On)					$V_s = 2.5 V, f = 1 MHz$
ADG1608	168			pF typ	
ADG1609	94			pF typ	
POWER REQUIREMENTS					V _{DD} = 5.5 V
lod	0.001			μA typ	Digital inputs = $0 \text{ V or } V_{DD}$
			1.0	µA max	
V _{DD}			3.3/16	V min/max	

3.3 V SINGLE SUPPLY

 V_{DD} = 3.3 V, V_{SS} = 0 V, GND = 0 V, unless otherwise noted.

Table 4.

15 0.28 5.5 ±0.5 ±1 ±2 ±1 ±2	0 V to V _{DD} 16.5 0.3 6.5 ±3 ±14 ±7 ±14 2.0 0.8 ±0.1 542	V Ω typ Ω typ Ω typ nA typ nA max nA typ nA max nA typ nA max nA typ nA max NA typ nA max v min V max nA typ μA max pF typ ns typ ns typ	$\begin{array}{l} V_{S}=0 \ V \ to \ V_{DD}, \ I_{S}=-10 \ mA; \ see \ Figure \ 25, \ V_{DD}=3.3 \ V, \\ V_{SS}=0 \ V \\ V_{S}=0 \ V \ to \ V_{DD}, \ I_{S}=-10 \ mA \\ V_{S}=0 \ V \ to \ V_{DD}, \ I_{S}=-10 \ mA \\ V_{DD}=3.6 \ V, \ V_{SS}=0 \ V \\ V_{S}=0.6 \ V/3 \ V, \ V_{D}=3 \ V/0.6 \ V; \ see \ Figure \ 26 \\ V_{S}=0.6 \ V/3 \ V, \ V_{D}=3 \ V/0.6 \ V; \ see \ Figure \ 26 \\ V_{S}=0.6 \ V/3 \ V, \ V_{D}=3 \ V/0.6 \ V; \ see \ Figure \ 26 \\ V_{S}=V_{D}=0.6 \ V \ or \ 3 \ V; \ see \ Figure \ 27 \\ \end{array}$
0.28 5.5 ±0.5 ±2 ±1 ±2	16.5 0.3 6.5 ± 3 ± 14 ± 7 ± 14 2.0 0.8 ± 0.1	Ω typ Ω typ Ω typ nA typ nA max nA typ nA max nA typ nA max nA typ nA max NA typ nA max V min V max nA typ μA max pF typ	$V_{SS} = 0 V$ $V_{S} = 0 V to V_{DD}, I_{S} = -10 mA$ $V_{S} = 0 V to V_{DD}, I_{S} = -10 mA$ $V_{DD} = 3.6 V, V_{SS} = 0 V$ $V_{S} = 0.6 V/3 V, V_{D} = 3 V/0.6 V; see Figure 26$ $V_{S} = 0.6 V/3 V, V_{D} = 3 V/0.6 V; see Figure 27$ $V_{IN} = V_{D} = 0.6 V \text{ or } 3 V; see Figure 27$ $V_{IN} = V_{GND} \text{ or } V_{DD}$ $R_{L} = 300 \Omega, C_{L} = 35 \text{ pF}$
0.28 5.5 ±0.5 ±2 ±1 ±2	0.3 6.5 ± 3 ± 14 ± 7 ± 14 2.0 0.8 ± 0.1	Ω typ Ω typ nA typ nA max nA typ nA max nA typ nA max nA typ nA max NA typ μA max pF typ ns typ	$V_{SS} = 0 V$ $V_{S} = 0 V to V_{DD}, I_{S} = -10 mA$ $V_{S} = 0 V to V_{DD}, I_{S} = -10 mA$ $V_{DD} = 3.6 V, V_{SS} = 0 V$ $V_{S} = 0.6 V/3 V, V_{D} = 3 V/0.6 V; see Figure 26$ $V_{S} = 0.6 V/3 V, V_{D} = 3 V/0.6 V; see Figure 27$ $V_{IN} = V_{D} = 0.6 V \text{ or } 3 V; see Figure 27$ $V_{IN} = V_{GND} \text{ or } V_{DD}$ $R_{L} = 300 \Omega, C_{L} = 35 \text{ pF}$
5.5 ±0.5 ±2 ±1 ±2	6.5 ±3 ±14 ±7 ±14 2.0 0.8 ±0.1	Ω typ nA typ nA max nA typ nA max nA max nA max nA typ nA max V min V max nA typ μA max pF typ ns typ	$\begin{split} V_S &= 0 \ V \ to \ V_{DD}, \ I_S = -10 \ mA \\ V_{DD} &= 3.6 \ V, \ V_{SS} = 0 \ V \\ V_S &= 0.6 \ V/3 \ V, \ V_D = 3 \ V/0.6 \ V; \ see \ Figure \ 26 \\ V_S &= 0.6 \ V/3 \ V, \ V_D = 3 \ V/0.6 \ V; \ see \ Figure \ 26 \\ V_S &= V_D = 0.6 \ V \ or \ 3 \ V; \ see \ Figure \ 27 \\ \end{split}$
±0.5 ±2 ±1 ±2	±3 ±14 ±7 ±14 2.0 0.8 ±0.1	nA typ nA max nA typ nA max nA max nA typ nA max V min V max nA typ µA max pF typ ns typ	$\begin{split} V_{DD} &= 3.6 \text{ V}, \text{ V}_{SS} = 0 \text{ V} \\ V_{S} &= 0.6 \text{ V}/3 \text{ V}, V_{D} = 3 \text{ V}/0.6 \text{ V}; \text{ see Figure 26} \\ V_{S} &= 0.6 \text{ V}/3 \text{ V}, V_{D} = 3 \text{ V}/0.6 \text{ V}; \text{ see Figure 26} \\ V_{S} &= V_{D} = 0.6 \text{ V or 3 V}; \text{ see Figure 27} \\ \end{split}$
±2 ±1 ±2	±14 ±7 ±14 2.0 0.8 ±0.1	nA max nA typ nA max nA max nA typ nA max V min V max nA typ µA max pF typ ns typ	$V_{S} = 0.6 \text{ V/3 V, } V_{D} = 3 \text{ V/0.6 V; see Figure 26}$ $V_{S} = 0.6 \text{ V/3 V, } V_{D} = 3 \text{ V/0.6 V; see Figure 26}$ $V_{S} = V_{D} = 0.6 \text{ V or 3 V; see Figure 27}$ $V_{IN} = V_{GND} \text{ or } V_{DD}$ $R_{L} = 300 \Omega, C_{L} = 35 \text{ pF}$
±2 ±1 ±2	±14 ±7 ±14 2.0 0.8 ±0.1	nA max nA typ nA max nA max nA typ nA max V min V max nA typ µA max pF typ ns typ	$V_{s} = 0.6 \text{ V/3 V}, V_{D} = 3 \text{ V/0.6 V}; \text{ see Figure 26}$ $V_{s} = V_{D} = 0.6 \text{ V or 3 V}; \text{ see Figure 27}$ $V_{IN} = V_{GND} \text{ or } V_{DD}$ $R_{L} = 300 \Omega, C_{L} = 35 \text{ pF}$
±2 ±1 ±2	±14 ±7 ±14 2.0 0.8 ±0.1	nA typ nA max nA max nA typ nA max V min V max nA typ µA max pF typ ns typ	$V_{s} = V_{D} = 0.6 \text{ V or } 3 \text{ V; see Figure } 27$ $V_{IN} = V_{GND} \text{ or } V_{DD}$ $R_{L} = 300 \Omega, C_{L} = 35 \text{ pF}$
±1 ±2	±7 ±14 2.0 0.8 ±0.1	nA max nA max nA typ nA max V min V max nA typ µA max pF typ ns typ	$V_{s} = V_{D} = 0.6 \text{ V or } 3 \text{ V; see Figure } 27$ $V_{IN} = V_{GND} \text{ or } V_{DD}$ $R_{L} = 300 \Omega, C_{L} = 35 \text{ pF}$
±1 ±2	±7 ±14 2.0 0.8 ±0.1	nA max nA typ nA max V min V max nA typ µA max pF typ ns typ	$V_{IN} = V_{GND} \text{ or } V_{DD}$ $R_L = 300 \Omega, C_L = 35 \text{ pF}$
±2	±14 2.0 0.8 ±0.1	nA typ nA max V min V max nA typ μA max pF typ ns typ	$V_{IN} = V_{GND} \text{ or } V_{DD}$ $R_L = 300 \Omega, C_L = 35 \text{ pF}$
	2.0 0.8 ±0.1	nA max V min V max nA typ µA max pF typ ns typ	$V_{IN} = V_{GND} \text{ or } V_{DD}$ $R_L = 300 \Omega, C_L = 35 \text{ pF}$
	2.0 0.8 ±0.1	V min V max nA typ µA max pF typ ns typ	R _L = 300 Ω, C _L = 35 pF
498	0.8 ±0.1	V max nA typ µA max pF typ ns typ	R _L = 300 Ω, C _L = 35 pF
498	0.8 ±0.1	V max nA typ µA max pF typ ns typ	R _L = 300 Ω, C _L = 35 pF
498	±0.1	nA typ µA max pF typ ns typ	R _L = 300 Ω, C _L = 35 pF
498		μA max pF typ ns typ	R _L = 300 Ω, C _L = 35 pF
498		pF typ ns typ	•
498	542	ns typ	•
498	542		•
498	542		•
498	542	ns max	V _s = 1.5 V; see Figure 28
		ns typ	$R_L = 300 \Omega$, $C_L = 35 pF$
331	344	ns max	$V_s = 1.5 V$; see Figure 30
		ns typ	$R_L = 300 \Omega, C_L = 35 pF$
367	411	ns max	$V_s = 1.5 V$; see Figure 30
		ns typ	$R_L = 300 \Omega$, $C_L = 35 pF$
	48	ns min	$V_{S1} = V_{S2} = 1.5 V$; see Figure 29
		pC typ	$V_s = 1.5 V$, $R_s = 0 \Omega$, $C_L = 1 nF$; see Figure 31
		dB typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 100 kHz$; see Figure 32
		dB typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 100 kHz$; see Figure 34
		% typ	$R_L = 110 \Omega$, f = 20 Hz to 20 kHz, V _s = 2 V p-p; see Figure 35 $R_L = 50 \Omega$, $C_L = 5 pF$; see Figure 33
		MHz typ	
		MHz typ	
			Vs = 1.5 V, f = 1 MHz
		P. 9P	$V_{s} = 1.5 V, f = 1 MHz$
		pF typ	
		P. 9P	V _s = 1.5 V, f = 1 MHz
		pE typ	
		P: 9P	V _{DD} = 3.6 V
		uA typ	$V_{DD} = 3.0 V$ Digital inputs = 0 V or V_{DD}
	1.0	µA max	
			pF typ pF typ pF typ pF typ pF typ μA typ

CONTINUOUS CURRENT PER CHANNEL, S OR D

Table 5. ADG1608

Parameter	25°C	85°C	125°C	Unit
CONTINUOUS CURRENT, S OR D				
$V_{DD} = +5 V, V_{SS} = -5 V$				
TSSOP ($\theta_{JA} = 112.6^{\circ}C/W$)	290	180	100	mA max
LFCSP ($\theta_{JA} = 48.7^{\circ}C/W$)	470	255	120	mA max
$V_{DD} = 12 V, V_{SS} = 0 V$				
TSSOP ($\theta_{JA} = 112.6^{\circ}C/W$)	213	129	73	mA max
LFCSP ($\theta_{JA} = 48.7^{\circ}C/W$)	346	185	84	mA max
$V_{DD} = 5 V, V_{SS} = 0 V$				
TSSOP ($\theta_{JA} = 112.6^{\circ}C/W$)	157	101	63	mA max
LFCSP ($\theta_{JA} = 48.7^{\circ}C/W$)	252	150	77	mA max
$V_{DD} = 3.3 V, V_{SS} = 0 V$				
TSSOP ($\theta_{JA} = 112.6^{\circ}C/W$)	126	87	56	mA max
LFCSP ($\theta_{JA} = 48.7^{\circ}C/W$)	206	129	73.5	mA max

Table 6. ADG1609

Parameter	25°C	85°C	125°C	Unit
CONTINUOUS CURRENT, S OR D				
$V_{DD} = +5 V, V_{SS} = -5 V$				
TSSOP ($\theta_{JA} = 112.6^{\circ}C/W$)	147	98	63	mA max
LFCSP ($\theta_{JA} = 48.7^{\circ}C/W$)	245	147	77	mA max
$V_{DD} = 12 V, V_{SS} = 0 V$				
TSSOP ($\theta_{JA} = 112.6^{\circ}C/W$)	157	101	63	mA max
LFCSP ($\theta_{JA} = 48.7^{\circ}C/W$)	255	150	77	mA max
$V_{DD} = 5 V, V_{SS} = 0 V$				
TSSOP ($\theta_{JA} = 112.6^{\circ}C/W$)	115	80	52	mA max
LFCSP ($\theta_{JA} = 48.7^{\circ}C/W$)	189	119	70	mA max
$V_{DD} = 3.3 V, V_{SS} = 0 V$				
TSSOP ($\theta_{JA} = 112.6^{\circ}C/W$)	94	66	45	mA max
LFCSP ($\theta_{JA} = 48.7^{\circ}C/W$)	154	101	63	mA max

ABSOLUTE MAXIMUM RATINGS

 $T_A = 25^{\circ}C$, unless otherwise noted.

Table 7.

Parameter	Rating
V _{DD} to V _{SS}	18 V
V _{DD} to GND	–0.3 V to +18 V
Vss to GND	+0.3 V to -18 V
Analog Inputs ¹	V _{ss} – 0.3 V to V _{DD} + 0.3 V or 30 mA, whichever occurs first
Digital Inputs ¹	GND – 0.3 V to V _{DD} + 0.3 V or 30 mA, whichever occurs first
Peak Current, S or D	710 mA (pulsed at 1 ms, 10% duty cycle maximum)
Continuous Current, S or D ²	Data + 15%
Operating Temperature Range	
Industrial	-40°C to +125°C
Storage Temperature Range	–65°C to +150°C
Junction Temperature	150°C
16-Lead TSSOP, θ _{JA} Thermal Impedance, 0 Airflow (4-Layer Board)	112.6°C/W
16-Lead LFCSP, θJA Thermal Impedance, 0 Airflow (4-Layer Board)	48.7°C/W
Reflow Soldering Peak Temperature, Pb-free	260°C

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

¹ Overvoltages at IN, S, or D are clamped by internal diodes. Current should be limited to the maximum ratings given.

² See Table 5 and Table 6.

PIN CONFIGURATIONS AND FUNCTION DESCRIPTIONS

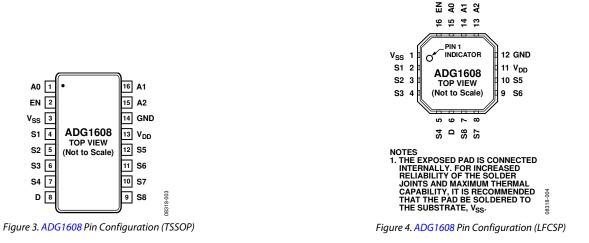


Table 8. ADG1608 Pin Function Descriptions

Pin	No.		
TSSOP	LFCSP	Mnemonic	Description
1	15	A0	Logic Control Input.
2	16	EN	Active High Digital Input. When this pin is low, the device is disabled and all switches are off. When this pin is high, Ax logic inputs determine on switches.
3	1	Vss	Most Negative Power Supply Potential. In single-supply applications, this pin can be connected to ground.
4	2	S1	Source Terminal 1. Can be an input or an output.
5	3	S2	Source Terminal 2. Can be an input or an output.
6	4	S3	Source Terminal 3. Can be an input or an output.
7	5	S4	Source Terminal 4. Can be an input or an output.
8	6	D	Drain Terminal. Can be an input or an output.
9	7	S8	Source Terminal 8. Can be an input or an output.
10	8	S7	Source Terminal 7. Can be an input or an output.
11	9	S6	Source Terminal 6. Can be an input or an output.
12	10	S5	Source Terminal 5. Can be an input or an output.
13	11	V _{DD}	Most Positive Power Supply Potential.
14	12	GND	Ground (0 V) Reference.
15	13	A2	Logic Control Input.
16	14	A1	Logic Control Input.
N/A	EP	EP	Exposed Pad. The exposed pad is connected internally. For increased reliability of the solder joints and maximum thermal capability, it is recommended that the pad be soldered to the substrate, V _{SS} .

Table 9. ADG1608 Truth Table

A2	A1	AO	EN	On Switch	
X ¹	X ¹	X ¹	0	None	
0	0	0	1	1	
0	0	1	1	2	
0	1	0	1	3	
0	1	1	1	4	
1	0	0	1	5	
1	0	1	1	6	
1	1	0	1	7	
1	1	1	1	8	

¹ X = don't care.

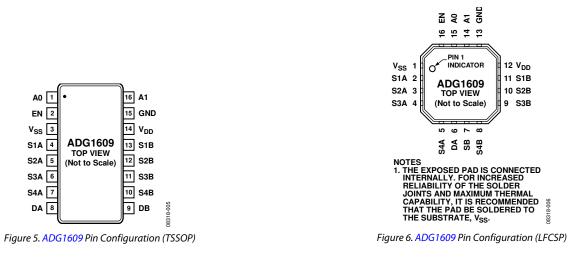


Table 10. ADG1609 Pin Function Descriptions

Pin No.					
TSSOP	TSSOP LFCSP Mnemonic		Description		
1	15	A0	Logic Control Input.		
2	16	EN	Active High Digital Input. When this pin is low, the device is disabled and all switches are off. When this pin is high, Ax logic inputs determine on switches.		
3	1	Vss	Most Negative Power Supply Potential. In single-supply applications, this pin can be connected to ground.		
4	2	S1A	Source Terminal 1A. Can be an input or an output.		
5	3	S2A	Source Terminal 2A. Can be an input or an output.		
6	4	S3A	Source Terminal 3A. Can be an input or an output.		
7	5	S4A	Source Terminal 4A. Can be an input or an output.		
8	6	DA	Drain Terminal A. Can be an input or an output.		
9	7	DB	Drain Terminal B. Can be an input or an output.		
10	8	S4B	Source Terminal 4B. Can be an input or an output.		
11	9	S3B	Source Terminal 3B. Can be an input or an output.		
12	10	S2B	Source Terminal 2B. Can be an input or an output.		
13	11	S1B	Source Terminal 1B. Can be an input or an output.		
14	12	V _{DD}	Most Positive Power Supply Potential.		
15	13	GND	Ground (0 V) Reference.		
16	14	A1	Logic Control Input.		
N/A	EP	EP	Exposed Pad. The exposed pad is connected internally. For increased reliability of the solder joints and maximum thermal capability, it is recommended that the pad be soldered to the substrate, V_{SS} .		

Table 11. ADG1609 Truth Table

A1	A0	EN	On Switch Pair
X ¹	X ¹	0	None
0	0	1	1
0	1	1	2
1	0	1	3
1	1	1	4

 1 X = don't care.

TYPICAL PERFORMANCE CHARACTERISTICS

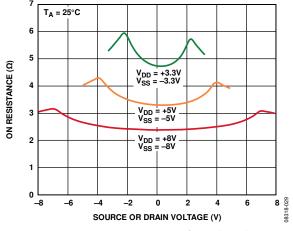


Figure 7. On Resistance vs. V_D (V_s) for Dual Supply

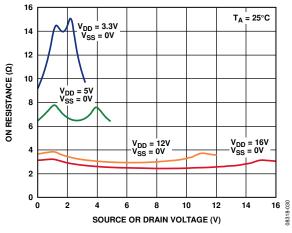


Figure 8. On Resistance vs. V_D (V_s) for Single Supply

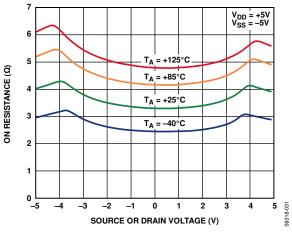


Figure 9. On Resistance vs. $V_{\rm D}$ (Vs) for Different Temperatures, ± 5 V Dual Supply

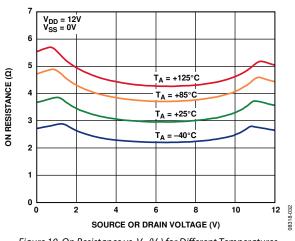


Figure 10. On Resistance vs. V_D (Vs) for Different Temperatures, 12 V Single Supply

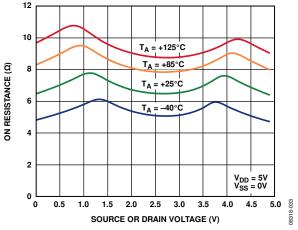


Figure 11. On Resistance vs. V_D (V_s) for Different Temperatures, 5 V Single Supply

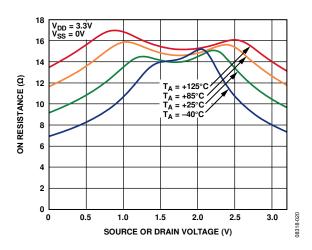


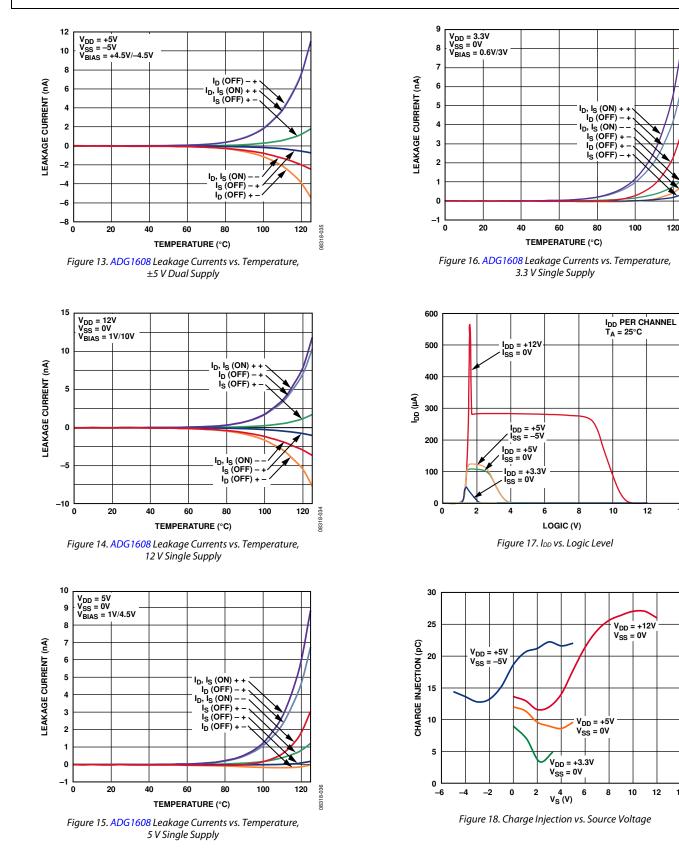
Figure 12. On Resistance vs. V_D (V_s) for Different Temperatures, 3.3 V Single Supply

120 ⁸¹⁰⁻⁸¹⁸⁸

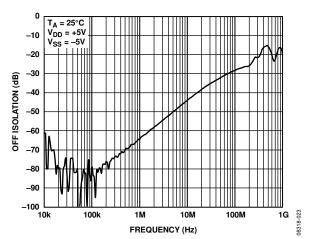
14 610-81800

08318-026

14



450 T_A = 25°C 400 350 TRANSITION TIME (ns) $V_{\text{DD}} = +3.3 \text{V}, \, \text{V}_{\text{SS}} = 0 \text{V}$ 300 250 200 /_{DD} = +5V, V_{SS} = 0V 150 100 $V_{DD} = +5V, V_{SS} = -5V$ 50 12V, V_{SS} • 0V DD/ 0 └_ -40 -20 0 20 40 60 80 100 120 08318-024 TEMPERATURE (°C) Figure 19. Transition Time vs. Temperature





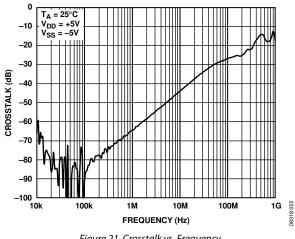
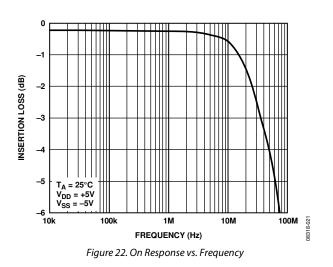
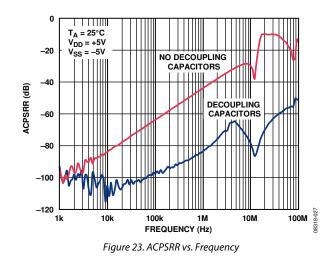
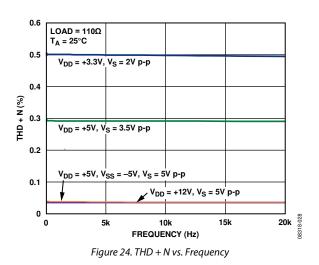


Figure 21. Crosstalk vs. Frequency

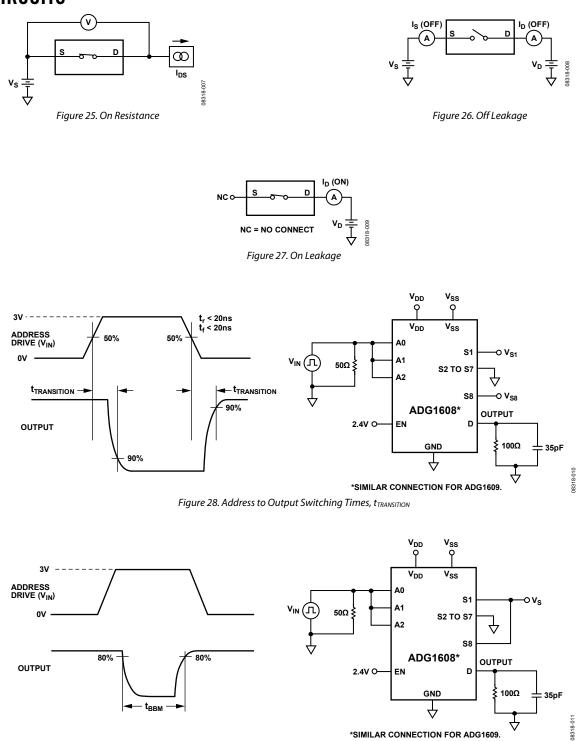
ADG1608/ADG1609







TEST CIRCUITS



*SIMILAR CONNECTION FOR ADG1609. Figure 29. Break-Before-Make Delay, t_{BBM}

Data Sheet

ADG1608/ADG1609

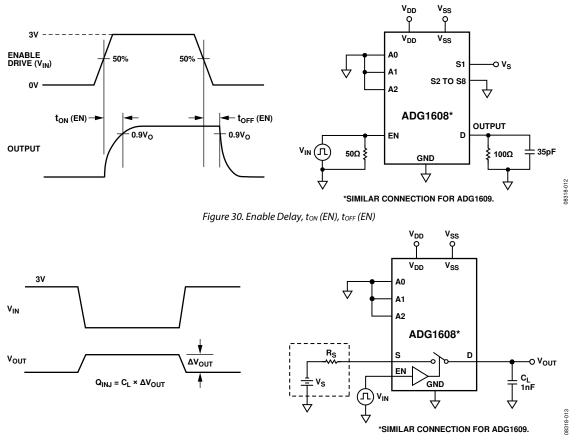


Figure 31. Charge Injection

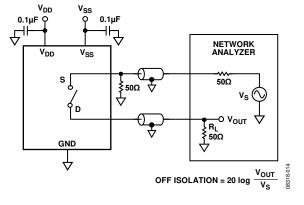


Figure 32. Off Isolation

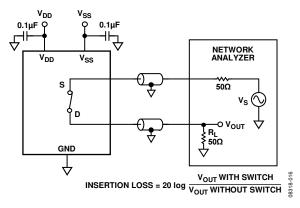


Figure 33. Bandwidth

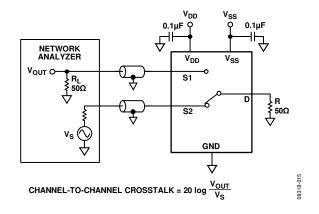


Figure 34. Channel-to-Channel Crosstalk

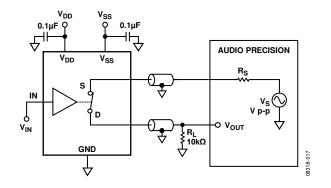


Figure 35. THD + Noise

TERMINOLOGY

Idd

The positive supply current.

Iss

The negative supply current.

 \mathbf{V}_{D} (\mathbf{V}_{S}) The analog voltage on Terminal D and Terminal S.

 \mathbf{R}_{ON} The ohmic resistance between Terminal D and Terminal S.

 $\mathbf{R}_{\text{FLAT(ON)}}$ Flatness that is defined as the difference between the maximum and minimum value of on resistance measured over the specified analog signal range.

Is (Off) The source leakage current with the switch off.

 \mathbf{I}_{D} (Off) The drain leakage current with the switch off.

 $I_{\text{D}}, I_{\text{S}}\left(\text{On}\right)$ The channel leakage current with the switch on.

 \mathbf{V}_{INL} The maximum input voltage for Logic 0.

V_{INH} The minimum input voltage for Logic 1.

I_{INL} (I_{INH}) The input current of the digital input.

Cs (Off) The off switch source capacitance, which is measured with reference to ground.

 C_D (Off) The off switch drain capacitance, which is measured with reference to ground.

 C_D , C_S (On) The on switch capacitance, which is measured with reference to ground.

ADG1608/ADG1609

Cin

The digital input capacitance.

t_{TRANSITION}

The delay time between the 50% and 90% points of the digital input and switch on condition when switching from one address state to another.

t_{ON} (EN)
 The delay between applying the digital control input and the output switching on.

 $t_{\text{OFF}} \left(EN \right)$ The delay between applying the digital control input and the output switching off.

Charge Injection A measure of the glitch impulse transferred from the digital input to the analog output during switching.

Off Isolation A measure of unwanted signal coupling through an off switch.

Crosstalk

A measure of unwanted signal that is coupled through from one channel to another as a result of parasitic capacitance.

Bandwidth

The frequency at which the output is attenuated by 3 dB.

On Response The frequency response of the on switch.

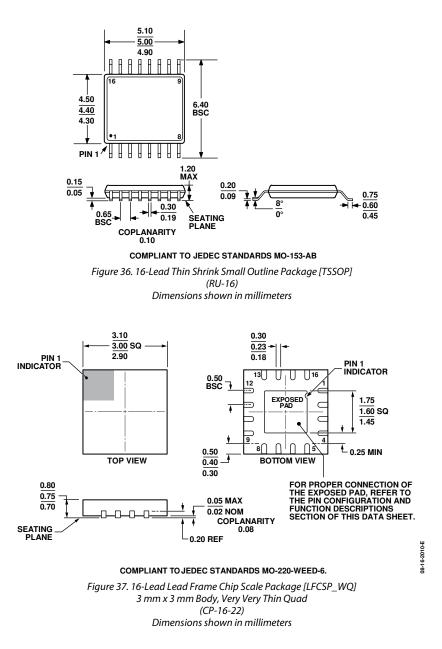
Insertion Loss The loss due to the on resistance of the switch.

Total Harmonic Distortion + Noise (THD + N) The ratio of the harmonic amplitude plus noise of the signal to the fundamental.

AC Power Supply Rejection Ratio (ACPSRR)

The ratio of the amplitude of signal on the output to the amplitude of the modulation. This is a measure of the ability of the part to avoid coupling noise and spurious signals that appear on the supply voltage pin to the output of the switch. The dc voltage on the device is modulated by a sine wave of 0.62 V p-p.

OUTLINE DIMENSIONS



ORDERING GUIDE

			Package	
Model ¹	Temperature Range	Package Description	Option	Branding
ADG1608BRUZ	-40°C to +125°C	16-Lead Thin Shrink Small Outline Package [TSSOP]	RU-16	
ADG1608BRUZ-REEL7	-40°C to +125°C	16-Lead Thin Shrink Small Outline Package [TSSOP]	RU-16	
ADG1608BCPZ-REEL7	-40°C to +125°C	16-Lead Lead Frame Chip Scale Package [LFCSP_WQ]	CP-16-22	S38
ADG1609BRUZ	-40°C to +125°C	16-Lead Thin Shrink Small Outline Package [TSSOP]	RU-16	
ADG1609BRUZ-REEL7	-40°C to +125°C	16-Lead Thin Shrink Small Outline Package [TSSOP]	RU-16	
ADG1609BCPZ-REEL7	-40°C to +125°C	16-Lead Lead Frame Chip Scale Package [LFCSP_WQ]	CP-16-22	S39

 1 Z = RoHS Compliant Part.

NOTES

NOTES

©2009–2015 Analog Devices, Inc. All rights reserved. Trademarks and registered trademarks are the property of their respective owners. D08318-0-9/15(A)

Rev. A | Page 20 of 20

www.analog.com